



SANYO Semiconductors

DATA SHEET

An ON Semiconductor Company

RD0504T — Diffused Junction Silicon Diode

Low VF • High-Speed Switching Diode

Features

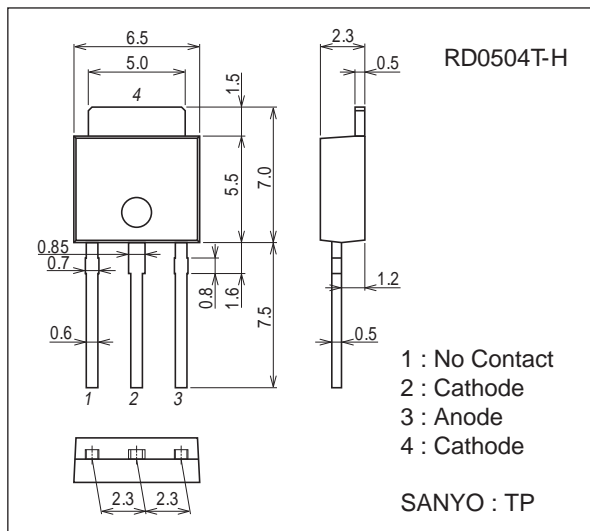
- $V_{RRM}=400V$
- $t_{rr}=17ns$ (typ.)($I_F=0.5A$, $I_R=1A$)
- $V_F \max=1.5V$
- Halogen free compliance

Specifications

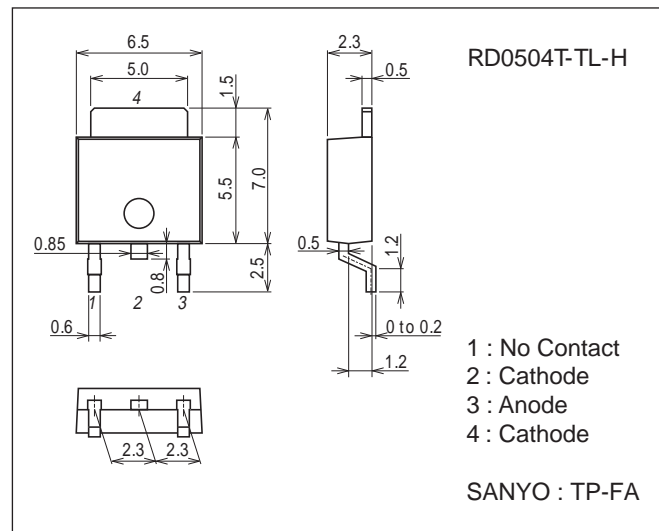
Absolute Maximum Ratings at $T_a=25^\circ C$

Parameter	Symbol	Conditions	Ratings	Unit
Repetitive Peak Reverse Voltage	V_{RRM}		400	V
Average Output Current	I_O		5	A
Surge Forward Current	I_{FSM}	Sine wave 10ms, 1 cycle	40	A
Junction Temperature	T_J		150	$^\circ C$
Storage Temperature	T_{stg}		-55 to +150	$^\circ C$

Package Dimensions unit : mm (typ)
7518-002

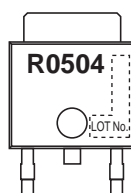


Package Dimensions unit : mm (typ)
7003-001

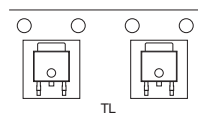


Product & Package Information

- Package : TP
- JEITA, JEDEC : SC-64, TO-251
- Minimum Packing Quantity : 500 pcs./bag
- Package : TP-FA
- JEITA, JEDEC : SC-63, TO-252
- Minimum Packing Quantity : 700 pcs./reel

Marking
(TP, TP-FA)

Packing Type (TP-FA) : TL



Electrical Connection



SANYO Semiconductor Co., Ltd.

<http://semicon.sanyo.com/en/network>

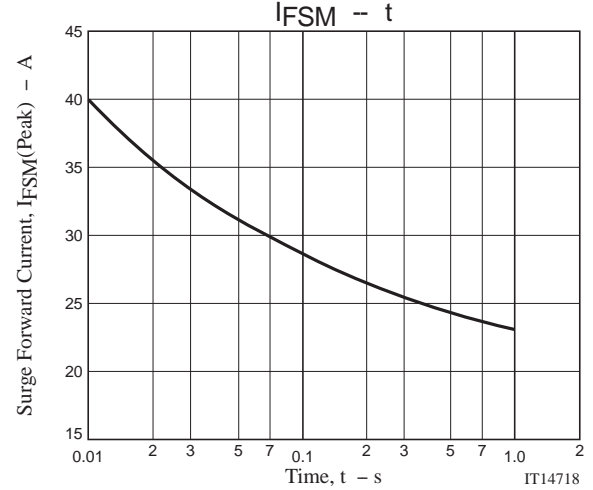
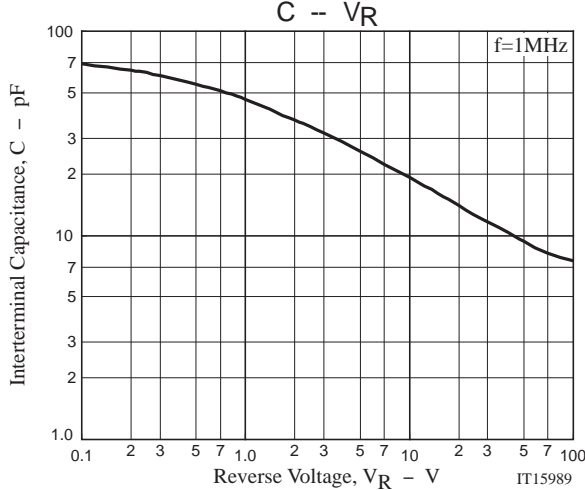
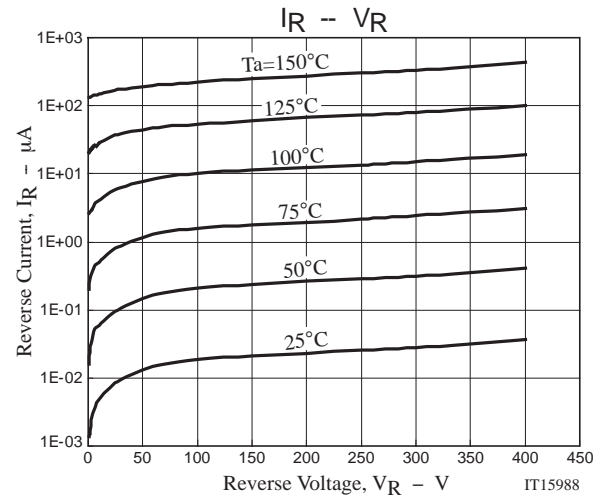
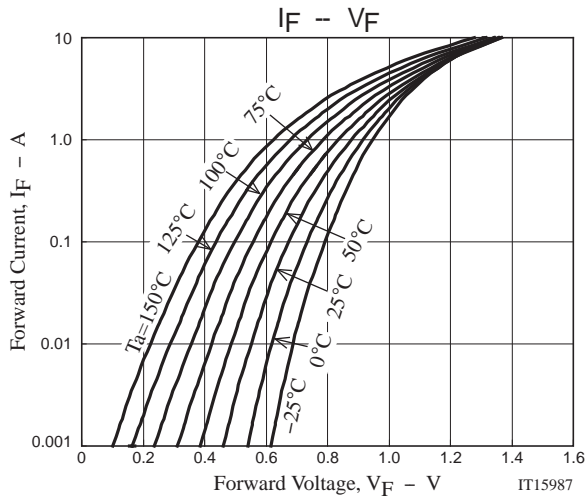
RD0504T

Electrical Characteristics at Ta=25°C

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Reverse Voltage	V_R	$I_R=1mA$	400			V
Forward Voltage	V_F	$I_F=5A$		1.2	1.5	V
Reverse Current	I_R	$V_R=400V$			20	μA
Reverse Recovery Time	t_{rr1}	$I_F=5A, di/dt=100A/\mu s$		40	50	ns
	t_{rr2}	$I_F=0.5A, I_R=1A$		17		ns
Thermal Resistance	$R_{th(j-c)}$	Junction - Case		6		$^{\circ}C/W$

Ordering Information

Device	Package	Shipping	memo
RD0504T-H	TP	500pcs./bag	Pb Free and halogen Free
RD0504T-TL-H	TP-FA	700pcs./reel	



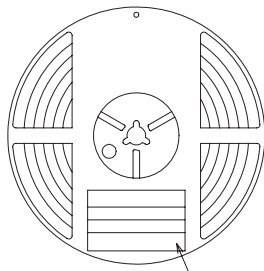
Taping Specification

RD0504T-TL-H

Packing Format

Package Name	Carrier Tape Type	Maximum Number of devices contained (pcs)			Packing format	
		Reel	Inner box	Outer box	Inner BOX (C-1)	Outer BOX (A-7)
TP-FA	TP	700	2,100	12,600	3 reels contained Dimensions:mm (external) 183×72×185	6 inner boxes contained Dimensions:mm (external) 440×195×210

Packing method



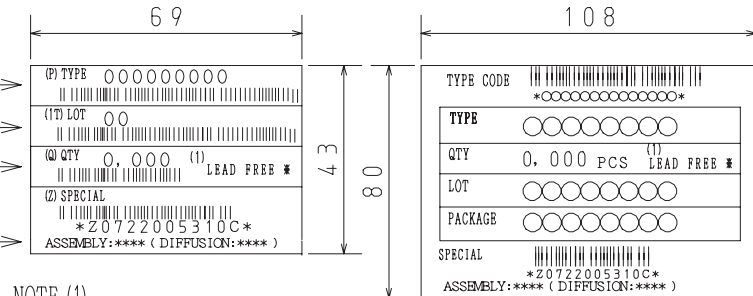
Reel label

Type No.
LOT No.
Quantity
Origin

Reel label, Inner box label
(unit:mm)

Outer box label

It is a label at the time of factory shipments.
The form of a label may change in physical
distribution process.



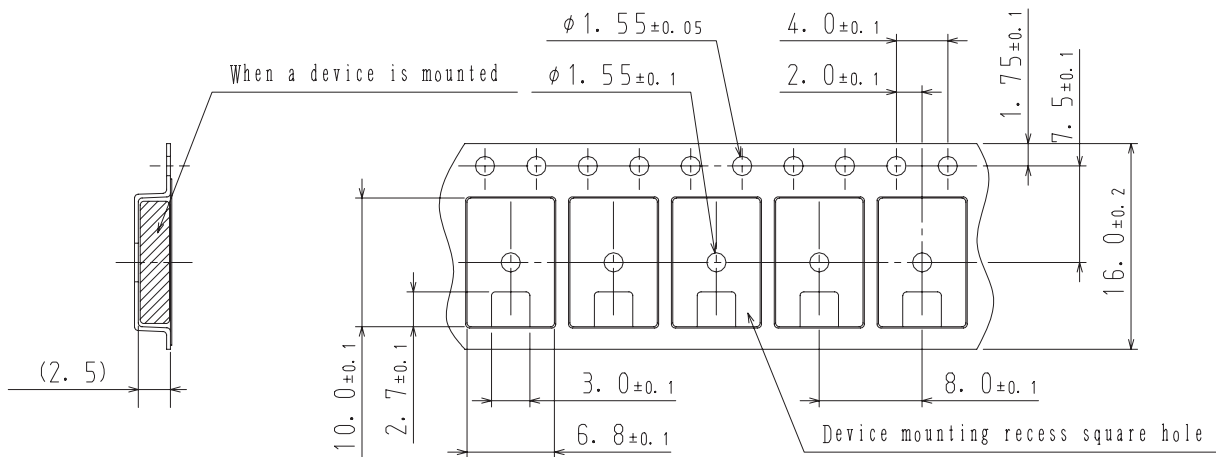
NOTE (1)

The LEAD FREE * description shows that the surface
treatment of the terminal is lead free.

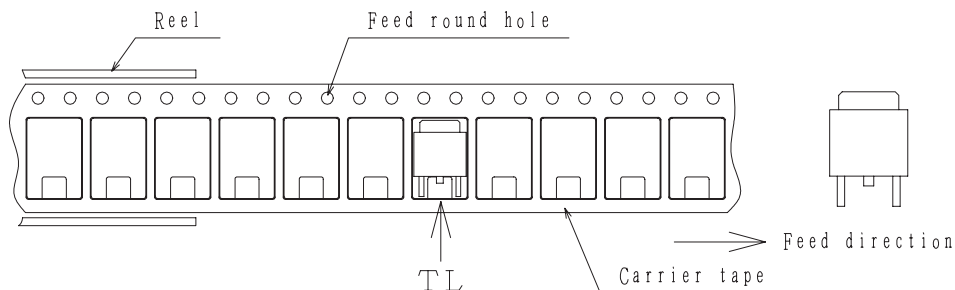
Label	JEITA Phase
LEAD FREE 3	JEITA Phase 3A
LEAD FREE 4	JEITA Phase 3

Taping configuration

1. Carrier tape size (unit:mm)

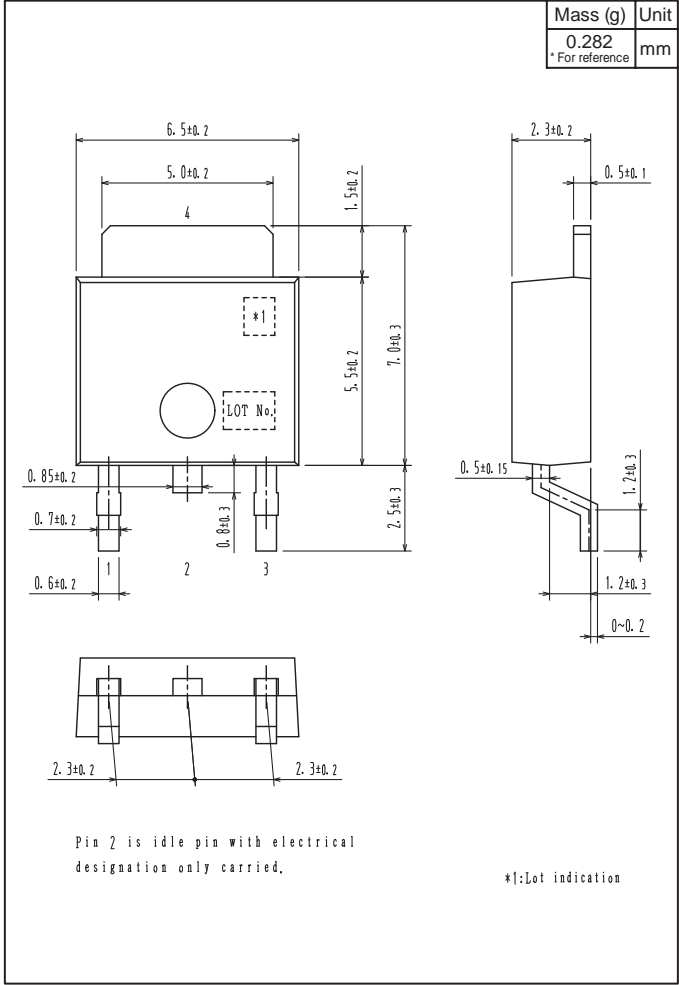


2. Device placement direction

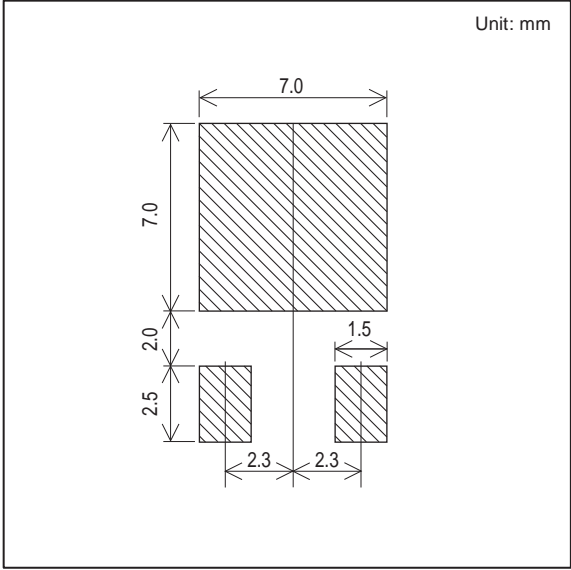


Those with one electrode terminal on the feed hole side.....TL

Outline Drawing
RD0504-TL-H



Land Pattern Example

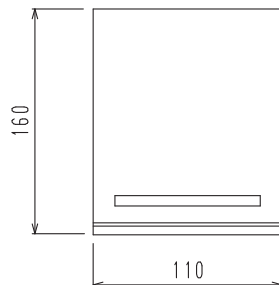
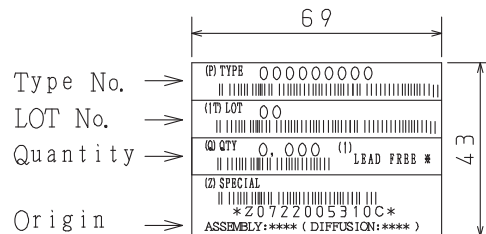


Bag Packing Specification

RD0504T-H

1. Packing Format

Package Name	Maximum Number of devices contained (pcs)			
	Bag	Inner box	Outer box	
TP	500	B-1	A-1	A-2
		10, 000	50, 000	30, 000
		Packing format (Dimensions:mm (external))		
		Inner box	Outer box	
		B-1	A-1	A-2
		445×225×55	470×250×300	470×250×190

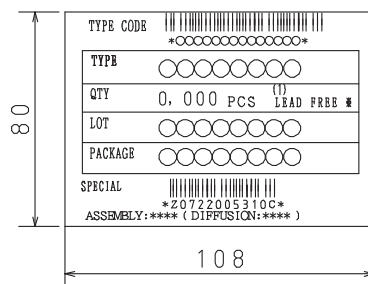
2. Bag dimensions
(unit:mm)3. Bag label, Inner box label
(unit:mm)4. Outer box label
(unit:mm)

It is a label at the time of factory shipments.
The form of a label may change in physical
distribution process,

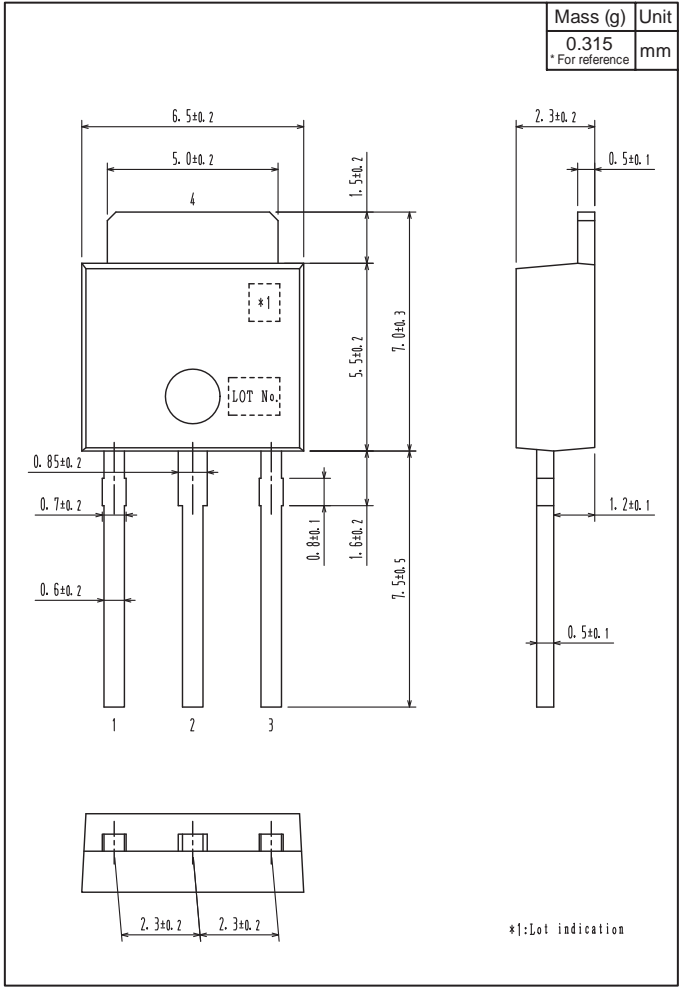
NOTE (1)

The LEAD FREE * description shows that the
surface treatment of the terminal is lead free.

Label	JEITA Phase
LEAD FREE 3	JEITA Phase 3A
LEAD FREE 4	JEITA Phase 3



Outline Drawing
RD0504T-H



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